# 1 Characteristics

Symbol	Parameter	Value	Unit		
I <sub>T(RMS)</sub>	On-state rms current (full sine wave) $T_c = 141 \ ^{\circ}C$		4	А	
I	Non repetitive surge peak on-state current (full cycle, T <sub>j</sub> initial = 25 °C)	F = 60 Hz	t = 16.7 ms	42	٨
ITSM		F = 50 Hz	t = 20 ms	40	A
ľt	I <sup>2</sup> t Value for fusing	t <sub>p</sub> = 10 ms	t <sub>p</sub> = 10 ms		A <sup>2</sup> s
dl/dt	Critical rate of rise of on-state current $I_G = 2 \ x \ I_{GT}$ , $t_r \leq 100 \ ns$	F = 120 Hz	T <sub>j</sub> = 150 °C	50	A/µs
V <sub>DSM</sub> /V <sub>RSM</sub>	Non repetitive surge peak off-state voltage	t <sub>p</sub> = 10 ms	T <sub>j</sub> = 25 °C	V <sub>DRM</sub> /V <sub>RRM</sub> + 100	V
I <sub>GM</sub>	Peak gate current $t_p = 20 \ \mu s$ $T_j = 150 \ ^{\circ}C$		4	А	
P <sub>G(AV)</sub>	Average gate power dissipation $T_j = 150 \text{ °C}$			1	W
T <sub>stg</sub> T <sub>j</sub>	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 150	°C

#### Table 2. Absolute maximum ratings

#### Table 3.Electrical characteristics (T<sub>i</sub> = 25 °C, unless otherwise specified)

Symbol	Test conditions	Quadrant	Min.	Max.	Unit	
I <sub>GT</sub>	V 10.V D 20.0	-    -	1	10	mA	
V <sub>GT</sub>	$V_D = 12 V R_L = 33 \Omega$	-    -		1.0	V	
V <sub>GD</sub>	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$	-    -	0.15		V	
I <sub>H</sub> <sup>(1)</sup>	I <sub>T</sub> = 100 mA		25	mA		
1	1 - 121	-		30		
ΙL	$I_{\rm G} = 1.2 I_{\rm GT}$	II		35	– mA	
dV/dt <sup>(1)</sup>	$V_D = 67\% V_{DRM,}$ gate open, $T_j = 150 \text{ °C}$	75		V/µs		
(dl/dt)c <sup>(1)</sup>	Logic level, 0.1 V/µs, T <sub>j</sub> = 150 °C		5.7		A/ms	
	Logic level, 15 V/µs, T <sub>j</sub> = 150 °C	1.5		7,0113		

1. For both polarities of A2 referenced to A1.

					1
Symbol	Test cond	Value	Unit		
V <sub>T</sub> <sup>(1)</sup>	I <sub>TM</sub> = 5.6 A, t <sub>p</sub> = 380 μs	T <sub>j</sub> = 25 °C	MAX.	1.5	V
V <sub>t0</sub> <sup>(1)</sup>	Threshold voltage	T <sub>j</sub> = 150 °C	MAX.	0.80	V
R <sub>d</sub> <sup>(1)</sup>	Dynamic resistance	T <sub>j</sub> = 150 °C	MAX.	80.0	mΩ
	$V_{DRM} = V_{RRM}$	T <sub>j</sub> = 25 °C	MAX.	5	μA
I <sub>DRM</sub>		T <sub>j</sub> = 150 °C	MAX.	2.2	
I <sub>RRM</sub>	$V_D/V_R = 400 V$ (at peak mains voltage)	T <sub>j</sub> = 150 °C	MAX.	1.75	mA
	$V_D/V_R = 200 V$ (at peak mains voltage)	T <sub>j</sub> = 150 °C	MAX.	1.5	

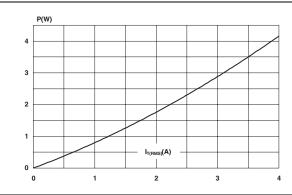
#### Table 4.Static characteristics

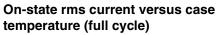
1. for both polarities of A2 referenced to A1.

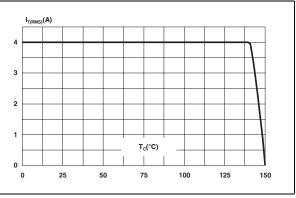
#### Table 5. Thermal resistance

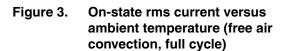
Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	Junction to case (AC)	2.20	°C/W
R <sub>th(j-a)</sub>	Junction to ambient	60	C/W

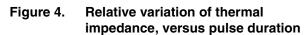
# Figure 1. Maximum power dissipation versus Figure 2. on-state rms current (full cycle)

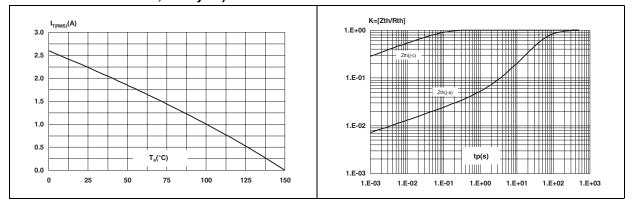








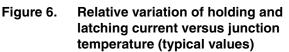


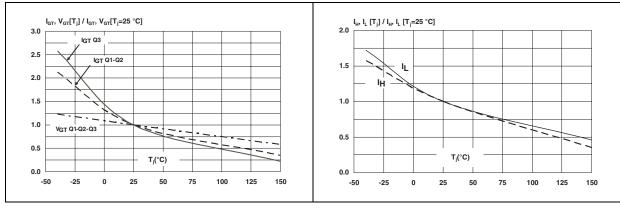




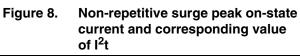
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# Figure 5. Relative variation of gate trigger Figure 5. Current and voltage versus junction temperature (typical values)





# Figure 7. Surge peak on-state current versus number of cycles



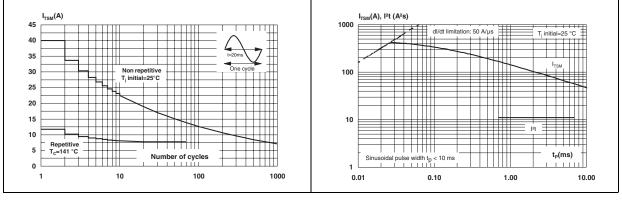
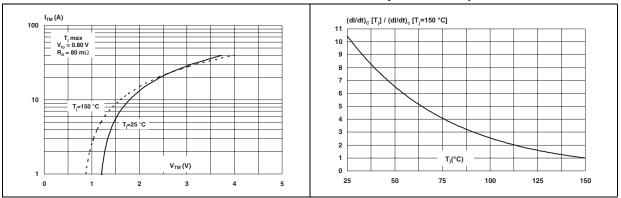


Figure 9. On-state characteristics (maximum values)

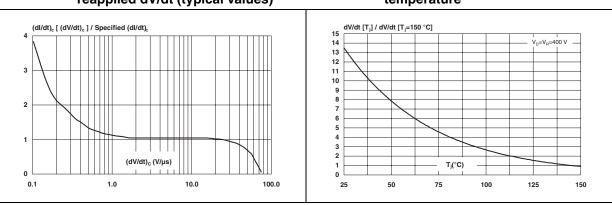
Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature





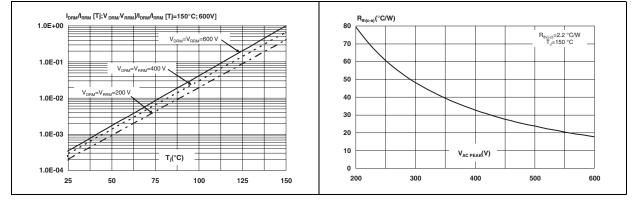
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#### Relative variation of critical rate of Figure 12. Relative variation of static dV/dt Figure 11. decrease of main current versus immunity versus junction reapplied dV/dt (typical values) temperature



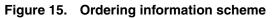
#### Figure 13. Variation of leakage current versus Figure 14. Acceptable case to ambient thermal junction temperature for different values of blocking voltage

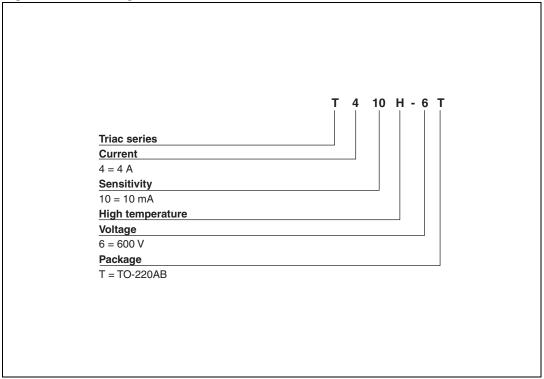
resistance versus repetitive peak off-state voltage





# 2 Ordering information scheme







### 3 Package information

- Epoxy meets UL94, V0
- Recommended torque 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

Table 6. TO-220AB dimensions

					Dimer	nsions		
		Ref.	Millimeters		Inches			
			Min.	Тур.	Max.	Min.	Тур.	Max.
		А	15.20		15.90	0.598		0.625
	€ ⊂ –  .	a1		3.75			0.147	
		a2	13.00		14.00	0.511		0.551
	2	В	10.00		10.40	0.393		0.409
	C2 ←	b1	0.61		0.88	0.024		0.034
A		b2	1.23		1.32	0.048		0.051
14 13 ···		С	4.40		4.60	0.173		0.181
		c1	0.49		0.70	0.019		0.027
		c2	2.40		2.72	0.094		0.107
		е	2.40		2.70	0.094		0.106
	M ▲→	F	6.20		6.60	0.244		0.259
* <u></u> +	-+H4	ØI	3.75		3.85	0.147		0.151
		14	15.80	16.40	16.80	0.622	0.646	0.661
		L	2.65		2.95	0.104		0.116
		12	1.14		1.70	0.044		0.066
		13	1.14		1.70	0.044		0.066
		М		2.60			0.102	



# 4 Ordering information

#### Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
T410H-6T	T410H 6T	TO-220AB	2.3 g	50	Tube

### 5 Revision history

#### Table 8.Document revision history

Date	Revision	Changes
15-May-2009	1	First issue.



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